multicomp PRO

Specification

Rating

: 50mA, DC 32V MAX.
1MA, DC 20MV MIN.

Compliant

 $\begin{array}{lll} \mbox{Initial Contact Resistance} & : 100 m \Omega \mbox{ Max.} \\ \mbox{Insluation Resistance} & : 100 V \mbox{ DC } 10 M \Omega \\ \mbox{Operating Force} & : 160/200/350gf \\ \mbox{General tolerances} & : \pm 0.2 mm \\ \mbox{Solder Thickness} & : 0.1 mm \\ \end{array}$

Operating Temperature Range : -40°C to +85°C Storage Temperature Range : -40°C to +85°C

Test conditions

Unless otherwise specified, the test and measurements shall be carried out as follows.

Ambient temperature : 5°C to 35°C
Relative humidity : 45% to 85%
Air pressure : 86 to 106 kPa

However, if doubt arises on the decision based on the measured values under the above-mentioned conditions, the following

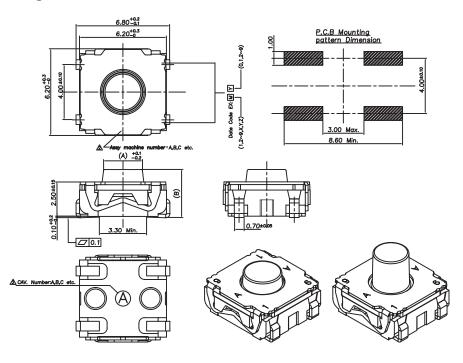
conditions shall be employed.

Ambient temperature : 20 ± 2 °C Relative humidity : 65 ± 5 %

Rating

Min Max Voltage : 20mV DC 32V DC
Min Max Current : 1mA 50 mA
Type of Actuation : Tactile feedback

Diagram





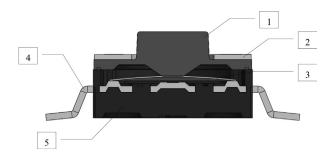
Dimensions: Millimetres (Inches)

Newark.com/multicomp-pro Farnell.com/multicomp-pro sg.element14.com/b/multicomp-pro





Item	Description	Q'ty	Materials	Treatment	
1	Stem		Silicone Rubber		
2	Cover		Stainless Steel	None	
3	Contact	1		With Cilver Dieties	
4	Terminal		Brass	With Silver Plating	
5	Base		High – Temp Thermoplastic LCP	Molded Black	



Test Sequence

Item	Description	Test Conditions	Requirements	
Appea	arance		•	
1	Visual Examination	By visual examination check without any out pressure & testing.	There shall be no defects that affect the serviceability of the product.	
Electr	ic Performanc	e		
2	Contact Resistance	Applying a static load 1.5 2 times the operating force to the center of the stem , measurements shall be made with a 1 kHz small current contact resistance meter	100mΩ Max.(Initial)	
3	Insulation Resistance	100V DC, 1 minute ± 5 sec.	10MΩ Min.	
4	withstand Voltage	250V AC (50Hz or 60 Hz 2mA) shall be applied between all the adjacent terminals and between the terminal and the frame for 1 minute.	No dielectric breakdown shall be occurred	
Mech	anical Perfprm	ance		
5	Bounce	3 to 4 operations at a rate of 1 cycles per second Switch Synchroscope 5V DC 5ΚΩ	5 m seconds Max.	







Mecha	Mechanical Perfprmance				
		Applied in the direction of operation.	N	R	S
1 h 1 '	Operation Force		160±50gf	200±50gf	350±100gf
7 Stroke	Placing the switch such that the direction of switch operation is vertical and then gradually increasing the load applied to the center of the stem to a stop shall	N	R	S	
		be measured	0.3±0.2mm	0.35 ±0.15mm	0.5±0.2mm
8	Control strength	The static load of 5kg shall be applied in the operating direction of the control unit for 60 seconds.	1) As shown in item 4~7 2) Contact Resistance: 200 mΩ Max. 3) Insulation Resistance: 10 MΩ Min		
9	Solder Heat Resistance	1) Soldering Temperature: 260±5°C 2) Duration of Solder Immersion: 5±1 sec 3) Frequency of Soldering Process 2 times Max. (PCB is 1.6mm in thickness	1) Shall be free from pronounced backlash and falling off or breakage terminals 2) As shown in item 4, 5 3) Contact Resistance: 200 mΩ Max 4) Insulation Resistance: 10MΩ Min		
Durab	oility		•		
10	Life Test	Measurements shall be made following the test forth below: 1) 5mA,5 V DC resistive load 2) Applying a static load the operating force to the center of the stem in the direction of operation 3) Cycle of Operation: 5,000,000 cycles ~160gf 500,000 cycles ~200gf 300,000 cycles ~350gf	1) Operating force:±50% of initial force 2) Contact 10 Ω Max 3) Insulation 10MΩ M in 4) Bounce:10 m seconds Max		
Envir	onmental Endu	ırance			
11	Vibration	Shall be vibrated in accordance with Method 201A of MIL-STD-202F 1) Frequency: 10 55 10 Hz 1 minute / 2) Direction: 3 vertical directions including the direction of operation. 3) Test Time: 2 hours each direction.	As shown in ite	em 2~5	
12	Shock	Shall be shocked in accordance with Method 213B condition A of MIL-STD-202F 1) Acceleration: 50G. 2) Action Time: 11 ± 1 m sec. 3) Testing Direction: 6 sides. 4) Test cycle: 3 times in each direction	As shown in item 2~5		
13	Cold Resistance	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before the measurements are made: 1. Temperature:40±2°C 2. Time:96 hours		item 4~7 stance : Less th tion resistance:	

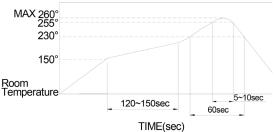
Newark.com/multicomp-pro Farnell.com/multicomp-pro sg.element14.com/b/multicomp-pro





14	Heat Resistance	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made : 1)Temperature :85°C ±2°C 2)Time: 96 hours	Ditto
15	Humidity Resistance	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1)Temperature: 60°C±2°C 2)Relative Humidity:90~95% 3)Time: 96 hour	Ditto
16	Change of temperature	After 5 cycles of following conditions, the switch shall be allowed to stan d under normal room temperature and humidity conditions for 1 hr, and measurement shall be made within, 1 hr after that. Water drops shall be removed. A = +60 °C B = -10 °C C = 2 H D = 1 H E = 2 H F = 1 H	Ditto

Soldering Conditions



- The condition mentioned above is the temperature on the Cu foil of the P.C.B surface. There are cases where board's temperature greatly differs from switch surface temperature depending on board's material, size, thickness, etc. Care, therefore, should be used not to allow switch's surface temperature to exceed 260°C.
- Manual Soldering

Soldering Temperature Max.350°C
Continuous Soldering Time Max. 5 seconds

Part Number Table

Description	Part Number	
Tactile Switch, 6mm × 6mm, J Pin, H4.3mm, 200gf	MPT6WJ4RGQR	
Tactile Switch, 6mm × 6mm, SMT, H4.3mm, 200gf	MPT6WM4RGQR	

Important Notice: This data sheet and its contents (the "Information") belong to the members of the AVNET group of companies (the "Group") or are licensed to it. No licence is granted for the use of it other than for information purposes in connection with the products to which it relates. No licence of any intellectual property rights is granted. The Information is subject to change without notice and replaces all data sheets previously supplied. The Information supplied is believed to be accurate but the Group assumes no responsibility for its accuracy or completeness, any error in or omission from it or for any use made of it. Users of this data sheet should check for themselves the Information and the suitability of the products for their purpose and not make any assumptions based on information included or omitted. Liability for loss or damage resulting from any reliance on the Information or use of it (including liability resulting from negligence or where the Group was aware of the possibility of such loss or damage arising) is excluded. This will not operate to limit or restrict the Group's liability for death or personal injury resulting from its negligence. Multicomp Pro is the registered trademark of Premier Farnell Limited 2019.

Newark.com/multicomp-pro Farnell.com/multicomp-pro sg.element14.com/b/multicomp-pro

